Surface Mount Schottky Power Rectifier

Plastic SOD-123 Package

This device uses the Schottky Barrier principle with a large area metal-to-silicon power diode. Ideally suited for low voltage, high frequency rectification or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system. This package also provides an easy to work with alternative to leadless 34 package style. Because of its small size, it is ideal for use in portable and battery powered products such as cellular and cordless phones, chargers, notebook computers, printers, PDAs and PCMCIA cards. Typical applications are AC-DC and DC-DC converters, reverse battery protection, and "Oring" of multiple supply voltages and any other application where performance and size are critical.

Features

- Guardring for Stress Protection
- Low Forward Voltage
- 125°C Operating Junction Temperature
- Epoxy Meets UL 94 V–0
- Package Designed for Optimal Automated Board Assembly
- ESD Ratings: Machine Model, C Human Body Model, 3B
- NRVB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Mechanical Characteristics

- Reel Options: MBR130LSFT1G = 3,000 per 7 in reel/8 mm tape
- Device Marking: L3L
- Polarity Designator: Cathode Band
- Weight: 11.7 mg (approximately)
- Case: Epoxy, Molded
- Lead Finish: 100% Matte Sn (Tin)
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Device Meets MSL 1 Requirements



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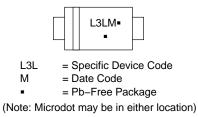
http://onsemi.com

SCHOTTKY BARRIER RECTIFIER 1.0 AMPERES, 30 VOLTS



SOD-123FL CASE 498

MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping [†]	
MBR130LSFT1G	SOD-123FL (Pb-Free)	3000/Tape & Reel	
NRVB130LSFT1G	SOD-123FL (Pb-Free)	3000/Tape & Reel	

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	30	V
Average Rectified Forward Current (At Rated V_R , T_L = 117°C)	Ι _Ο	1.0	А
Peak Repetitive Forward Current (At Rated V_R , Square Wave, 100 kHz, $T_L = 110^{\circ}C$)	I _{FRM}	2.0	A
Non-Repetitive Peak Surge Current (Non-Repetitive peak surge current, halfwave, single phase, 60 Hz)	I _{FSM}	40	A
Storage Temperature	T _{stg}	-55 to 150	°C
Operating Junction Temperature	TJ	-55 to 125	°C
Voltage Rate of Change (Rated V_R , $T_J = 25^{\circ}C$)	dv/dt	10,000	V/μs

THERMAL CHARACTERISTICS

P				
Thermal Resistance	e, Junction-to-Lead (Note 1)	R _{til}	26	°C/W
Thermal Resistance	e, Junction-to-Lead (Note 2)	R _{til}	21	
Thermal Resistance	e, Junction-to-Ambient (Note 1)	R _{tia}	325	
Thermal Resistance	e, Junction-to-Ambient (Note 2)	R _{tia}	82	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Mounted with minimum recommended pad size, PC Board FR4.
Mounted with 1 in. copper pad (Cu area 700 mm²).

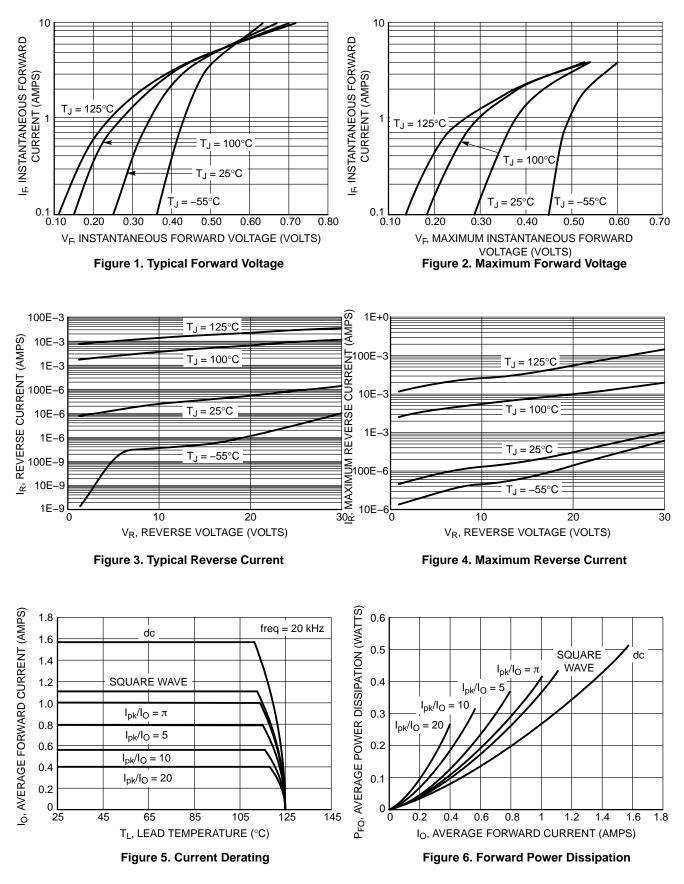
ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 3)	V _F	T _J = 25°C	$T_J = 100^{\circ}C$	V
$(I_F = 0.1 \text{ A})$ $(I_F = 0.7 \text{ A})$ $(I_F = 1.0 \text{ A})$		0.29 0.36 0.38	0.18 0.27 0.30	
Maximum Instantaneous Reverse Current (Note 3)	I _R	T _J = 25°C	T _J = 100°C	mA
(V _R = 30 V)		1.0	25	

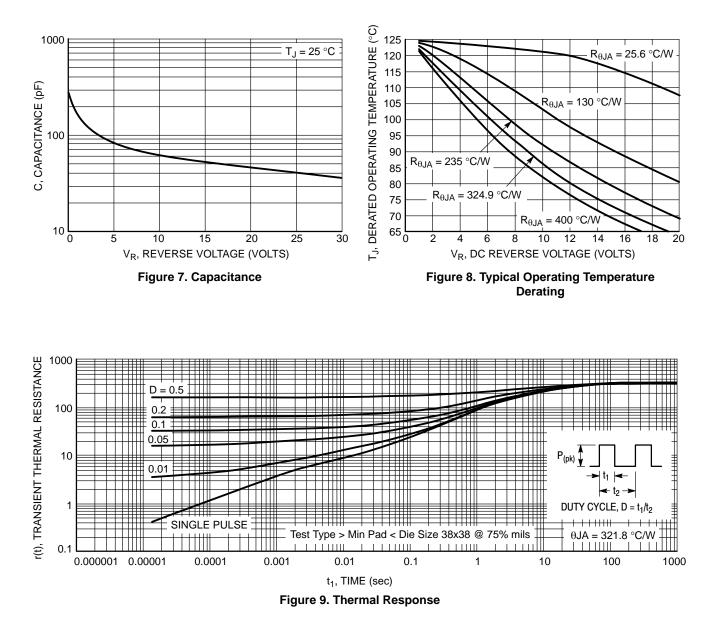
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Pulse Test: Pulse Width \leq 250 µs, Duty Cycle \leq 2%.

TYPICAL CHARACTERISTICS

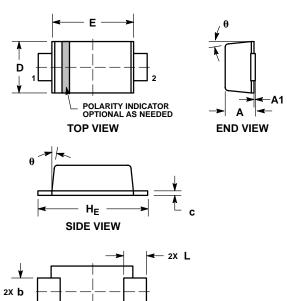


TYPICAL CHARACTERISTICS



PACKAGE DIMENSIONS

SOD-123LF **CASE 498** ISSUE D



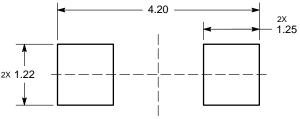
BOTTOM VIEW

NOTES DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
CONTROLLING DIMENSION: MILLIMETER.

DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH. DIMENSIONS D AND J ARE TO BE MEASURED ON FLAT SECTION 3. 4. OF THE LEAD: BETWEEN 0.10 AND 0.25 MM FROM THE LEAD TIP.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.90	0.95	0.98	0.035	0.037	0.039	
A1	0.00	0.05	0.10	0.000	0.002	0.004	
b	0.70	0.90	1.10	0.028	0.035	0.043	
С	0.10	0.15	0.20	0.004	0.006	0.008	
D	1.50	1.65	1.80	0.059	0.065	0.071	
Е	2.50	2.70	2.90	0.098	0.106	0.114	
L	0.55	0.75	0.95	0.022	0.030	0.037	
HE	3.40	3.60	3.80	0.134	0.142	0.150	
θ	0°	-	8°	0°	-	8°	

RECOMMENDED SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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